

Observation of Surface Layering in a Nonmetallic Liquid

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Oscillatory density profiles (layers) have previously been observed at the free surfaces of liquid metals but not in other isotropic liquids. We have used x-ray reflectivity to study a molecular liquid, tetrakis(2-ethylhexoxy)silane. When cooled to $T/T_c \approx 0.25$ (well above the freezing point for this liquid), density oscillations appear at the surface. Lateral order within the layers is liquidlike. Our results confirm theoretical predictions that a surface-layered state will appear even in dielectric liquids at sufficiently low temperatures, if not preempted by freezing.

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Until recently, the structure of a liquid surface was thought to be well understood [1]: The density changes monotonically from the density of the liquid to that of the vapor. However, Rice *et al.* [2] predicted in 1973 that there would be density oscillations (layers) at liquid metal surfaces. This theory assigned an essential role to the electron gas in causing an abrupt transition between the conducting liquid and nonconducting vapor, resulting in an effective wall potential. Starting in 1995, x-ray scattering experiments have established that such smecticlike order does exist near the surfaces of a number of liquid metals and metallic alloys [3–7]. (This phenomenon is distinct from surface freezing [8], which is a pretransition effect seen in certain liquids only just above the bulk freezing point, and where the surface layer is frozen, i.e., laterally ordered.) There have also been many x-ray studies of the surface profiles of classical dielectric liquids, including alkanes [9], ethanol [10], toluene [11], polymers and polymer solutions [11,12], and water [13,14], but these have shown no evidence of surface layers away from the freezing point.

The presence of an electron gas is the obvious feature that distinguishes metals from dielectrics, but in practice there are other differences. The surface tension of most liquid metals is very high (e.g., 500 mN/m for Hg), so that the surface is very smooth. Dielectric liquids have much lower surface tensions (<100 mN/m and frequently <40 mN/m) and, therefore, much rougher surfaces. Dielectric liquids are known to form layers at the surfaces of smooth hard substrates [15,16]. Therefore, one possibility is that dielectric liquids would show surface layering if only their free surfaces were not so rough [17]. Another possibility was raised by Chacón *et al.* [18], who concluded from simulations that surface layering will appear below about $0.2T_c$, where T_c is the critical temperature. In many liquid metals, the critical temperature is high and the melting temperature low; thus, low values of T/T_c can be reached within the liquid phase. For example, layering is seen in mercury at room temperature, where $T \approx 0.15T_c$. However, most classical dielectric liquids must be studied at much higher T/T_c (e.g., water freezes at $0.42T_c$). In

general, a low freezing point and high critical point are consequences of a broad and shallow pair potential; Li and Rice [19] have labeled such materials “Madrid liquids.”

The question, therefore, is whether the observed difference between metallic and dielectric liquid surfaces is due to the electron gas or whether surface layering is a universal property of liquids that may, in some cases, be preempted by freezing or masked by surface roughness.

We have studied the surface of a molecular liquid, tetrakis(2-ethoxyhexoxy)silane (TEHOS), using x-ray reflectivity. TEHOS is an isotropic (non-liquid-crystalline) dielectric liquid. The molecule consists of one Si and four O atoms in the center, surrounded by four saturated branched alkanes forming a “wax coating” that makes the molecules nonreactive and roughly spherical. It is used in outdoor devices such as transformers and solar cells, because it does not freeze in winter and also has very low evaporation loss. Neither the freezing point nor the critical point has been precisely determined, but viscosity measurements [20] have shown that it is a fluid down to at least 219 K. Using x-ray scattering in transmission, and differential scanning calorimetry, we have found no evidence of a bulk phase transition down to 190 K. The boiling point is 467 K at 1 mm Hg [20]. Using the Clausius-Clapeyron equation to estimate the normal boiling point, and then using the normal boiling point to estimate the critical temperature [21], we find that T_c is ~ 950 K. Thus, TEHOS is like a liquid metal in that it has a low melting point and a high critical point.

In order to easily cool the liquid, we prepared ~ 5000 Å films of TEHOS supported on silicon substrates. These were formed by putting a few drops of liquid on the substrate, allowing the liquid to spread, and then draining the excess [16]. These samples can be mounted in a closed-cycle refrigerator and then oriented as needed in a diffractometer. A somewhat similar method has been used previously to study liquid helium [22]. The liquid film thickness is much larger than relevant length scales (surface roughness, molecular dimensions, etc.). We saw no measurable changes in film thickness over at least 12 hours, which confirms that the evaporation rate is very low.

To avoid seeing features in the reflectivity due to the liquid-substrate interface, which is not of interest in the present study, we prepared and used substrates with rms surface roughness >20 Å. Yu *et al.* [16] have found, and we have verified, that the scattering features due to interfacial layers can no longer be seen when the substrate surface is rough. The internal interface contributes only a diffuse background to the reflectivity data. To prepare the rough silicon wafers, we started with polished silicon wafers and cleaned them using the procedure as described in Ref. [16]. We then etched them for 3 min in 6% hydrogen fluoride solution. This cleaning and etching procedure was repeated once and then the etched silicon wafers were cleaned once again.

TEHOS was purchased from GLEST, Inc., with a purity of $>95\%$ and used as supplied. Specular x-ray reflectivity studies were performed at MATRIX (Beam Line X18A, National Synchrotron Light Source) and MUCAT (Sector 6, Advanced Photon Source) using a conventional four-circle diffractometer. The beam size was ~ 0.8 mm vertically and ~ 1 mm horizontally. The momentum resolution was ~ 0.006 Å $^{-1}$. The samples were mounted on the cold head of a closed-cycle refrigerator and covered with a beryllium radiation shield, which helps to keep the sample temperature uniform. The cold head and the sample were then sealed under vacuum with a beryllium can. The whole system was pumped with a molecular turbo pump to maintain a vacuum. Before collecting data, the sample was kept at the desired temperature for at least 30 min for the system to reach equilibrium. In addition to specular scans, slightly off-specular “background” scans were performed and subtracted from the specular data, thus removing the scattering from all diffuse sources including that from the rough liquid-solid interface.

Figure 1 shows the specular reflectivity R divided by the Fresnel reflectivity R_F at several temperatures. At 237 K (and at higher temperatures, not shown here), the scans are featureless. At lower temperatures, distinct reflectivity oscillations are seen, indicating that there is some structure in the interfacial electron density $\rho(z)$ averaged over the surface plane. The change in the reflectivity data appears at the same temperature whether we are going up or down and does not have any detectable dependence on age or temperature history of the sample, x-ray exposure, etc. The temperature threshold corresponds to $T/T_c \approx 0.25$. This value of T/T_c is lower than has been reached during any other classical dielectric liquid surface studies.

The Patterson functions and both model-independent fits [23] and slab fits (not shown here) confirm that the reflectivity changes at 227 K and below result from the formation of surface layers. The fits we show in Fig. 1 use the “semi-infinite series of Gaussians” model frequently used to fit reflectivity data from liquid metal surfaces [5,14,24]. However, a series of equally spaced layers will not fit our data. Guided by our slab fits, we have modified the model function so that there is a different spacing (d_0) and a

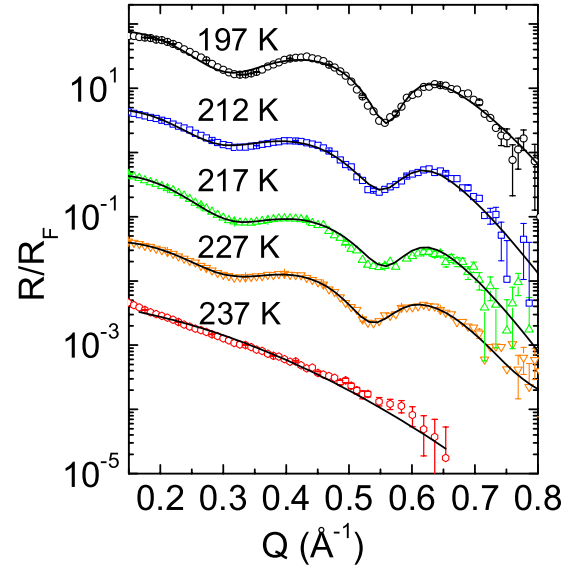


FIG. 1 (color online). Normalized specular reflectivity for ~ 5000 Å TEHOS films on rough silicon wafers at different temperatures. At 227 K and below, the reflectivity data develop structure, indicating a change in the surface density profile. Lines are best fits using the electron density profiles shown in Fig. 2.

different relative density (r) for the first two layers:

$$\frac{\rho}{\rho_{\text{bulk}}} = r \sum_{n=0}^1 \frac{d_0}{\sqrt{2\pi}\sigma_n} e^{-(z+nd_0)^2/2\sigma_n^2} + \sum_{n=2}^{\infty} \frac{d_1}{\sqrt{2\pi}\sigma_n} e^{-[z+(n-2)d_1+2d_0]^2/2\sigma_n^2}, \quad (1)$$

where $\sigma_n^2 = \sigma_0^2 + n\bar{\sigma}^2$, so that the width of the layer increases with layer number (i.e., with depth below the surface). Further, the starting width σ_0 is a combination of two terms: $\sigma_0^2 = \sigma_i^2 + \sigma_{\text{cw}}^2$, where σ_{cw} is due to thermal capillary waves and σ_i is an intrinsic term due to all other factors. Note that σ_{cw} is not a variable parameter: We have measured the surface tension as a function of temperature using a Wilhelmy-plate method in the range 265–305 K, extrapolated it to the temperature range of interest [25], and used this to calculate σ_{cw} [26]. Most of the fitting parameters show no clear trend with temperature: $d_0 = 8.4 \pm 0.2$ Å, $d_1 = 10.3 \pm 0.1$ Å, $\bar{\sigma} = 2.0 \pm 0.1$ Å, and $r = 1.15 \pm 0.02$. However, σ_0 increases with temperature, as expected, from 3.8 Å at 197 K to 4.2 Å at 227 K.

The solid lines in Fig. 1 show that good fits are obtained with this model. (For the featureless reflectivity curves at higher temperatures, we used the familiar one-layer model with an error-function-broadened interface.) Figure 2 shows the fitted densities. The dashed lines are the full best-fit density functions; the solid lines are the same functions except with $\sigma_{\text{cw}} = 0$. In other words, the solid lines show what the surface profiles would look like if they had not been broadened by thermal capillary waves.

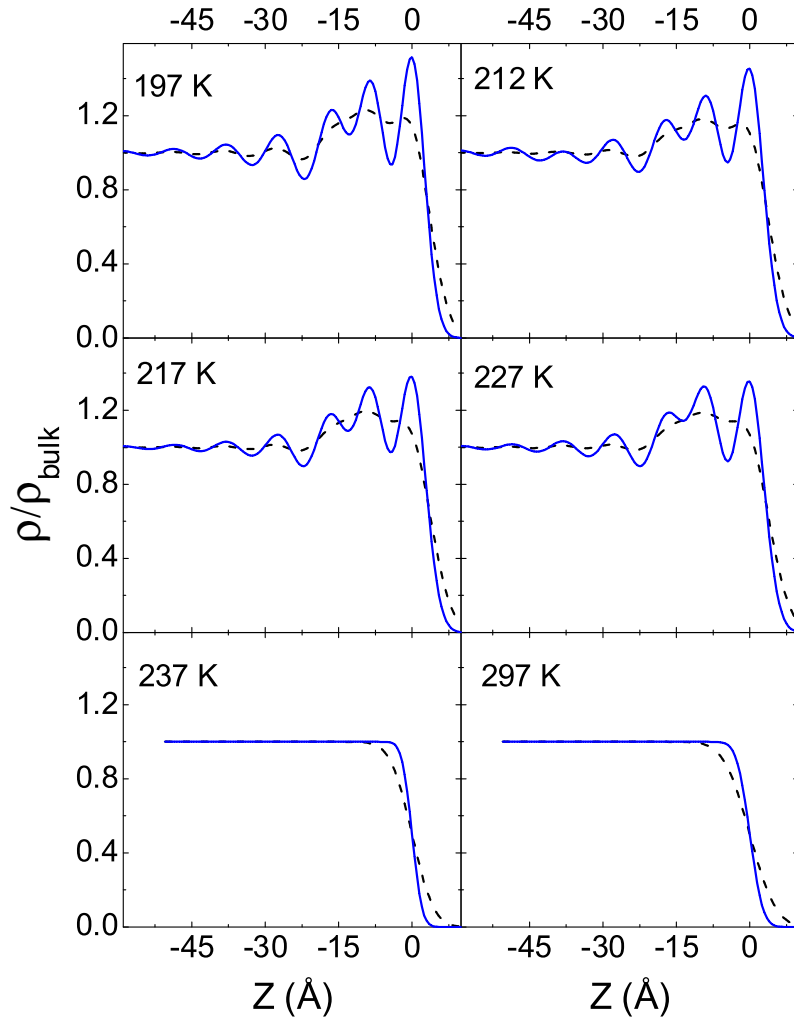


FIG. 2 (color online). The dashed lines show best-fit electron densities as functions of distance from the surface, for ~ 5000 Å TEHOS films on rough silicon wafers at different temperatures. The solid lines show the density profiles with capillary broadening removed (see text).

Could impurity segregation to the surface be responsible for the onset of layering? Impurities in liquids are mobile, and even the highest-purity liquids can have enough impurities to cover the surface if they were to migrate there. However, impurities will go to the surface only if this decreases the surface energy (surface tension), which will increase the thermal capillary wave amplitude and, thus, the surface width. In Fig. 3, we show the top surface width as a function of temperature. In order to fairly compare the function used at 227 K and below to that used at 237 K and above, we have defined the width as the distance from $\rho/\rho_{\text{bulk}} = 0.9$ to $\rho/\rho_{\text{bulk}} = 0.1$; thus, the absolute values will differ from widths calculated using other definitions. It can be seen in Fig. 3 that the surface width is monotonic; there is no increase at lower temperatures where layering appears. Also, since impurities are unlikely to be the same size as TEHOS molecules, the lateral short-range order in an impurity layer should be different from that of bulk TEHOS. Figure 4 shows grazing-incidence (surface sensitive) x-ray scattering data at 212 K, compared with bulk diffraction data (in transmission) at the same temperature. At the incident angle of 0.05° (the critical angle for liquid TEHOS is $\sim 0.10^\circ$), the x rays penetrate only ~ 100 Å into the liquid, which means that scattering from the ~ 30 Å

layered region is a significant fraction of the observed scattering. The bulk and surface data are not expected to look identical because of the very different scattering geometries, but there are no sharp features in either curve (i.e., there is only liquidlike surface order, just as in liquid metals), and the broad features have about the same posi-

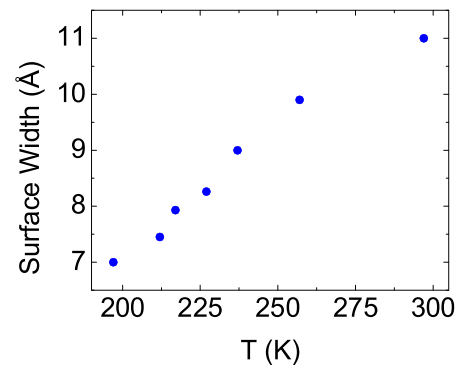


FIG. 3 (color online). Liquid surface width vs temperature. The surface width is defined as the distance from $\rho/\rho_{\text{bulk}} = 0.9$ to $\rho/\rho_{\text{bulk}} = 0.1$ in each best-fit electron density function (dashed lines in Fig. 2); thus, the absolute values will differ from widths calculated using other definitions.

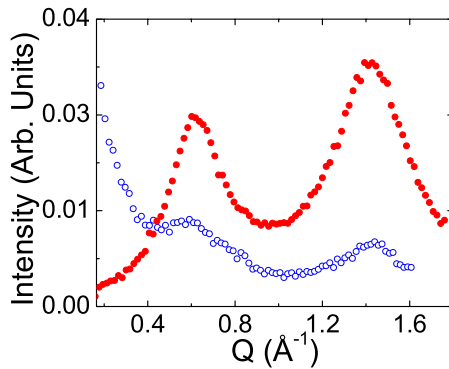


FIG. 4 (color online). Grazing-incidence (in-plane) scattering from a TEHOS surface (○), compared to scattering in transmission from a bulk TEHOS sample (●). The two curves show the same features, indicating that there is only liquidlike lateral order at the surface.

tions and widths in the two cases (i.e., there is no evidence of a different molecular species).

Shpyrko *et al.* have investigated the role of surface width by studying liquid potassium [5] and water [14]. The surface tension of liquid potassium is much lower than that of most liquid metals and comparable to that of water (~ 70 mN/m). From an analysis of differences in the x-ray reflectivity and diffuse scattering data, they conclude that there is surface layering in liquid potassium but none in water. The surface tension of TEHOS is ~ 32 mN/m at room temperature and ~ 35.5 mN/m (extrapolated) at 227 K; both these values are lower than those for water and potassium in the studies mentioned above. Thus, the observation of surface layering is not correlated with whether the surface tension is high or low, but neither does it depend on whether the liquid is a metal or a dielectric. On the other hand, potassium and water were not studied (and cannot easily be studied) at the same T/T_c : in the potassium study, $T/T_c \approx 0.15$, whereas for the water study, $T/T_c \approx 0.45$. Recall that the onset of layering in TEHOS is at $T/T_c \approx 0.25$. Thus, layering does appear at low T/T_c , as predicted [18], although there is as yet no evidence of a universal T/T_c threshold.

In summary, we have observed surface layering in a non-liquid-crystalline, nonmetallic liquid. The presence of an electron gas is not necessary.

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